

DEUTSCH* Stamped and Formed (S&F) Contacts

1. SCOPE

1.1. Content

This specification covers performance, tests and quality requirements for the TE Connectivity (TE) DEUTSCH Stamped and Formed Contact System.

1.2. Qualification

When tests are performed on the subject product line, procedures specified in Figure 2 shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

2. APPLICABLE DOCUMENTS

The following documents constitute a part of this specification to the extent specified herein. Unless otherwise indicated, the latest edition of the document applies.

2.1. TE Connectivity (TE) Documents

	•	109-1	General Requirements for Testing
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• 114-151000 DEUTSCH Size 16 S&F Pin & Socket (14-01, 14-10, 16-01, 16-06, 16-07, 16-09)

• 114-151001 DEUTSCH Size 16 S&F Pin & Socket (16-12, 16-14)

• 114-151002 DEUTSCH size 12 S&F Pin & Socket (12-01)

• 114-151003 DEUTSCH Size 20 S&F Pin & Socket (20-01, 20-02)

• 114-151006 DEUTSCH size 12 S&F Pin & Socket (12-02)

• Product Drawings. XX = plating codes. See individual product drawings for available plating.

1060-12-01XX 1060-12-02XX 1060-14-01XX 1060-14-10XX 1060-16-01XX 1060-16-06XX 1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 1060-20-06XX	Product Drawing Pin	Size
1060-12-02XX 1060-14-01XX 1060-14-10XX 1060-16-01XX 1060-16-06XX 1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-12-01XX	10
1060-14-10XX 1060-16-01XX 1060-16-06XX 1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-12-02XX	12
1060-16-01XX 1060-16-06XX 1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-14-01XX	
1060-16-06XX 1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-14-10XX	
1060-16-07XX 1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-16-01XX	
1060-16-09XX 1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-16-06XX	16
1060-16-12XX 1060-20-01XX 1060-20-02XX 20	1060-16-07XX	
1060-20-01XX 1060-20-02XX 20	1060-16-09XX	
1060-20-02XX 20	1060-16-12XX	
	1060-20-01XX	
1060-20-06XX	1060-20-02XX	20
	1060-20-06XX	

Product Drawing Socket	Size
1062-12-01XX	12
1062-12-02XX	12
1062-14-01XX	
1062-14-10XX	
1062-16-01XX	
1062-16-06XX	16
1062-16-07XX	10
1062-16-09XX	
1062-16-12XX	
1062-16-14XX	
1062-20-01XX	
1062-20-02XX	20
1062-20-03XX	20
1062-20-06XX	



2.2 Industry Documents

- DIN 72551-6: Road Vehicles—Low-Tension Cables—Part 6: Single-Core, Unscreened with Thin Insulation Wall; Dimensions, Materials, Marking
- ISO 6722: Road Vehicles—60 V and 600 V Single-Core Cables—Dimensions, Test Methods, and Requirements
- SAE J1128: Low Voltage Primary Cable
- SAE J2030: Heavy-Duty Electrical Connector Performance Standard
- USCAR-2: Performance Spec for Automotive Electrical Connector Systems

3. REQUIREMENTS

3.1. Design and Construction

Product shall be of the design, construction, materials, and physical dimensions specified on the applicable product drawing.

3.2. Ratings

- Voltage: See connector product specification
- Current (Amp): See Appendix A for current temperature rise (T-Rise) open air without housing

Contact Size	Wire Size ⁽²⁾ AWG [mm ²]	Current Rating (A)
12	10 [6.00-5.00] 12 [4.00-2.50]	25
	14 [2.00]	18
	12 [2.50]	
	14 [2.00]	13
16	16 [1.50-1.00]	
	18 [0.75-0.80]	10
	20 [0.50]	7.5
,	14 [2.00]	
	16 [1.50-1.00]	7.5
20	18 [0.75-0.80]	7.5
	20 [0.50]	
	22 [0.35]	5

• Temperature⁽¹⁾:

Nickel -55°C to +125°C
 Tin -55°C to +125°C
 Gold -55°C to +150°C
 Palladium Nickel Gold -55°C to +150°C



NOTE

- 1. See connector product specification for connector temperature range.
- 2. Metric wire sizes are for references only. (All contacts were validated with AWG wires.)

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3.3. Test Requirements and Procedures Summary

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

VISUAL

3.3.1. Examination of Product

A. Procedure: SAE J2030

- B. Method: Visually inspected for use of materials, proper construction, correct part number and insert markings and over-all quality of workmanship. Damaged or improperly manufactured contacts, galling of metal parts, nicks and burrs of metal parts were considered adequate basis for rejection.
- C. Requirement: The contacts shall be correctly constructed, marked and shall show good quality and workmanship
- 3.3.2. Low Level Contact Resistance (Dry Circuit)

A. Procedure: SAE J2030

- B. Method: Test with applied voltage not to exceed 20 mV open circuit and the test current shall be limited to 100 mA. The resistance of the equal length of wire (reference wire) shall be subtracted from the same reel as used for the connector wiring. Gold and tin plated contacts
- C. Requirement:

Wire Size	Resistance
AWG [mm ²]	mΩ max
16 [1.0]	6.0
18 [0.80]	7.5
20 [0.50]	11.0
22 [0.35]	17.0

3.3.3. Contact Resistance (Voltage Drop)

A. Procedure: SAE J2030

- B. Method: Using test currents as defined. The resistance of an equal length wire (reference wire) shall be subtracted from the actual readings to determine the added resistance of the terminal. The reference wire shall be from the same reel as used for the connector wiring.
- C. Requirement:

Contact Size	Wire Size AWG [mm²]	Test Currrent Amp	Voltage Drop max mV
12	10 [6.00-5.00] 12 [4.00-2.50]	25	
	14 [2.00]	18	
16	12 [2.50] 14 [2.00] 16 [1.50-1.00]	13	
	18 [0.75-0.80]	10	100
	20 [0.50]	7.5	
20	14 [2.00] 16 [1.50-1.00] 18 [0.75-0.80] 20 [0.50]	7.5	
	22 [0.35]	5	

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3.3.4. Maximum Current Capability (open air without housing)

A. Procedure: USCAR-2

- B. Method: Samples shall be mounted in an enclosure which protects the immediate environment from external movement of air. Measure and record the voltage drop across 150mm of the conductor to be used for the test. Attach conductor ends of the terminal pairs to form one continuous series circuit and attach the thermocouples to each mated pair. Mount the circuit in the draft-free enclosure. Use at least 10 terminal pairs. Test samples at room temperature then slowly adjust the power supply until current level of 50% of the maximum expected value for the wire size. Wait at least 15 minutes for the circuit temperature to stabilize. Increase in increments or 10% of that value until a temperature rise over ambient of 55°C was achieved. Record ambient temperature, temperature of each terminal pair interface and millivolt drop across each mated pair.
- C. Requirement: T-rise curve graph at 20% above current rating.

MECHANICAL

3.3.5. Crimp Tensile

A. Procedure: SAE J2030

B. Method: The tensile strength of the crimped connection shall be tested by using suitable apparatus at a constant speed within the range of 25 mm/min. If the terminal has a cable insulation crimp it shall be rendered mechanically ineffective. Samples are pulled to destruction.

a. Size 12 Crimp Specification: 114-151002 or 114-151006b. Size 16 Crimp Specification: 114-151000 or 114-151001

c. Size 20 Crimp Specification: 114-151003

C. Requirement:

Contact Size	Wire Size AW G	Wire Size m m²	Tensile Strength Minimum lbf[N]	
		6.00		
	10			
		5.00		
		4.00	70 [311]	
12	12			
		3.00		
		2.50		
	14		50 [222]	
		2.00	30 [222]	
	12			
		3.00		
		2.50		
	14			
		2.00	25 (444)	
16		1.50	25 [111]	
10	16			
		1.00		
	18			
		0.75		
	20		45 (07)	
		0.50	15 [67]	
20		2.50		
	14			
		2.00		
		1.50	00 1001	
	16		20 [89]	
		1.00		
	18			
		0.75		
	20			
		0.50	15 [67]	
	22	0.00		
		0.35	5 [22]	
		0.35		

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3.3.6. Contact Retention

A. Procedure: SAE J2030

B. Method: The contacts shall be subjected to a direct pull. The minimum value specified shall be applied for 1 minute. The pull is to be exerted on the conductor by means of a tension-testing machine or equivalent to prevent sudden or jerking force during test.

C. Requirement: See table. The terminal shall maintain its original position in the connector throughout the test.

Contact	Pull-Out Force
Size	lbf [N] min
12	30 [133]
16	25 [111]
20	20 [89]

3.3.7. Durability

A. Procedure: SAE J2030

B. Method: Test samples shall be mated and unmated complete cycles at room temperature.

a. Nickel: = 100 cyclesb. Gold: = 100 cycles

c. Palladium Nickel Gold: = 100 cycles

d. Tin: = 20 cycles

C. Requirement: No evidence of damage to the contacts, contact plating which may be detrimental to reliable contact performance.

3.3.8. Terminal-Terminal Insertion Force

A. Procedure: Not Applicable

B. Method: Sockets shall be mounted in a suitable fixture for applying gradually increasing loads for the insertion using a test pin. Insert test pin .200 [5.08] deep into socket.

C. Requirement: See table

Contact	Insertion Force	Test Pin Ø
Size	max lbf [N]	inch [mm]
12	2.50 [11.1]	.0946 [2.403]
16	2.50 [11.1]	.0615 [1.562]
20	1.50 [6.7]	.0410 [1.041]

3.3.9. Contact Overlap (electrical engagement)

A. Procedure: Not Applicable

B. Method: Theoretical proof by design calculation

C. Requirement: ≥ .050 [1.27]. Depends on connector design

ENVIRONMENTAL

3.3.10. Temperature Life

A. Procedure: SAE J2030

B. Method: The wired mated connectors shall be subjected to 1000 hours at +125°C without current flowing.

C. Requirement: Contact resistance not to exceed 100mV after test.

3.3.11. Thermal Cycle

A. Procedure: Not Applicable

B. Method: Cycle mated connectors from -55°C to +125°C. Connectors to remain at each temperature extreme for one (1) hour minimum. Mated connectors are to be cycled a total of 20 complete cycles.

C. Requirement: Contact resistance not to exceed 100mV after test.

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3.3.12. Thermal Shock

A. Procedure: SAE J2030

- B. Method: Subjected test sample to 10 cycles. One cycle shall consist of a soak time at -55°C then a transition within 2 min to an ambient of +125°C, with a soak time there and then a transition back to -55°C within 2 min. The soak times shall be established as the time necessary to bring the internal connector temperature on test to within 5°C of each of the ambient temperatures.
- C. Requirement: Contact resistance not to exceed 100mV after test.

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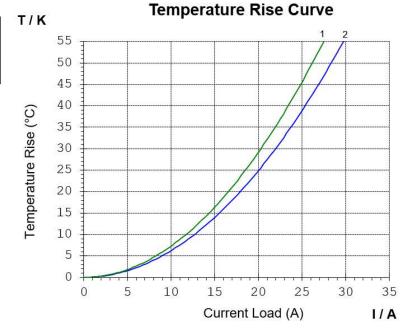
3.4. Appendix A. Current Temperature Rise (T-Rise) Open Air Without Housing

Size 12 - Nickel					
Pin	Soc	Conductor	Curve		
Part Number	Part Number	Conductor	Guive		
1060-12-0166	1062-12-0166	12 AWG	1		
1060-12-0222	1062-12-0222	10 AWG	2		



NOTE

T-rise curves indicate testing at 20% above rated current.

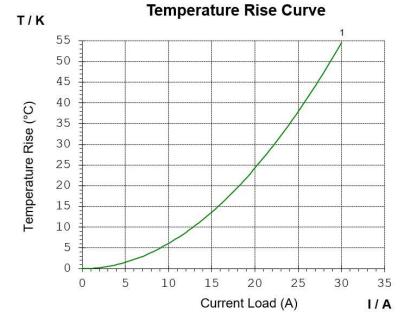


Size 12 - Gold				
Pin	Soc	Wire	Curve	
Part Number	Part Number	wiie	Curve	
1060-12-0144	1062-12-0144	12 AWG	1	



NOTE

T-rise curves indicate testing at 20% above rated current.



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Size 16 - Nickel					
Pin	Soc	Wire	Curve		
Part Number	Part Number	vviie	Curve		
1060-16-0622	1062-16-0622	20 AWG	1		
1060-16-0622	1062-16-0622				
1060-14-0122	1062-14-0122	18 AWG	2		
1060-16-0122	1062-16-0122				
1060-16-0722	1062-16-0722				
1060-16-0622	1062-16-0622		3		
1060-14-0122	1062-14-0122	16 AWG			
1060-16-0122	1062-16-0122	IO AWG			
1060-16-0722	1062-16-0722				
1060-14-0122	1062-14-0122				
1060-16-0122	1062-16-0122	14 AWG	4		
1060-16-0722	1062-16-0722				



NOTE

T-rise curves indicate testing at 20% above rated current.

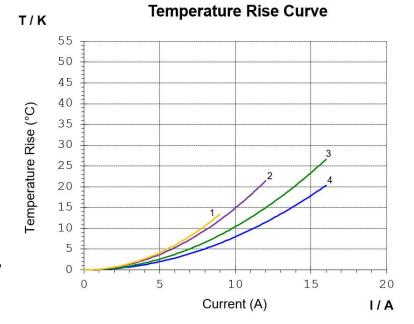
T/K	Temperature Rise Curve		
Temperature Rise (°C)	55 - 50 - 45 - 40 - 35 - 30 - 25 - 20 - 15 -	Temperature Rise Curve	
	5 -	5 10 15 20	
		Current (A)	

Size 16 - Gold				
Pin	Soc	10/:	Curve	
Part Number	Part Number	Wire		
1060-16-0644	1062-16-0644	20 AWG	1	
1060-16-0644	1062-16-0644			
1060-14-0144	1062-14-0144	18 AWG	2	
1060-16-0144	1062-16-0144	10 AWG		
1060-16-0744	1062-16-0744			
1060-16-0644	1062-16-0644		3	
1060-14-0144	1062-14-0144	16 AWG		
1060-16-0144	1062-16-0144	10 AWG		
1060-16-0744	1062-16-0744			
1060-14-0144	1062-14-0144			
1060-16-0144	1062-16-0144	14 AWG	4	
1060-16-0744	1062-16-0744			



NOTE

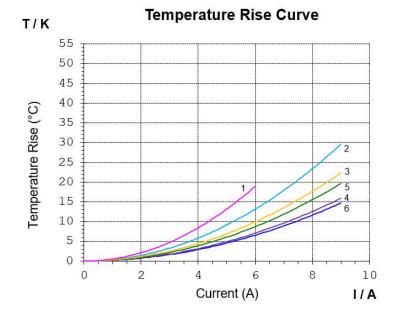
T-rise curves indicate testing at 20% above rated current.



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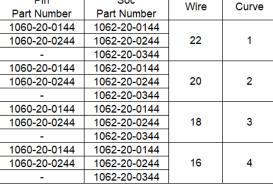
Size 20 - Nickel				
Pin	Soc	Wire	Curve	
Part Number	Part Number	vviie		
1060-20-0122	1062-20-0122			
1060-20-0222	1062-20-0222	22	1	
-	1062-20-0322			
1060-20-0122	1062-20-0122			
1060-20-0222	1062-20-0222	20	2	
-	1062-20-0322			
1060-20-0122	1062-20-0122		3	
1060-20-0222	1062-20-0222	18		
-	1062-20-0322			
1060-20-0122	1062-20-0122		4	
1060-20-0222	1062-20-0222	16		
-	1062-20-0322			
1060-20-0622	1062-20-0622	16	5	
1060-20-0622	1062-20-0622	14	6	



NOTE

T-rise curves indicate testing at 20% above rated current.

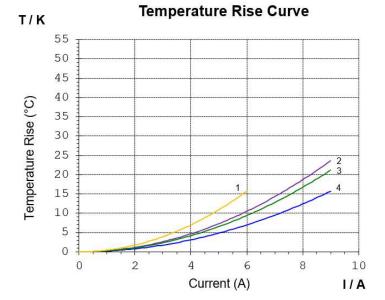
Size 20 - Gold				
Pin	Soc	Wire	Curve	
Part Number	Part Number	vviie		
1060-20-0144	1062-20-0144			
1060-20-0244	1062-20-0244	22	1	
-	1062-20-0344			
1060-20-0144	1062-20-0144		2	
1060-20-0244	1062-20-0244	20		
-	1062-20-0344			
1060-20-0144	1062-20-0144		3	
1060-20-0244	1062-20-0244	18		
-	1062-20-0344			
1060-20-0144	1062-20-0144			
1060-20-0244	1062-20-0244	16	4	
_	1062-20-0344			





NOTE

T-rise curves indicate testing at 20% above rated current.



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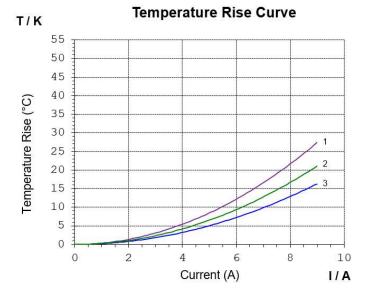


Size 20 - Tin				
Pin	Soc	Wire	Curve	
Part Number	Part Number	vviie		
1060-20-0177	1062-20-0177		1	
1060-20-0277	1062-20-0277	20		
-	1062-20-0377			
1060-20-0177	1062-20-0177		2	
1060-20-0277	1062-20-0277	18		
-	1062-20-0377			
1060-20-0177	1062-20-0177			
1060-20-0277	1062-20-0277	16	3	
-	1062-20-0377			



NOTE

T-rise curves indicate testing at 20% above rated current.



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4. REVISION HISTORY

Rev Ltr	Brief Description of Change	Date	Dwn	Apvd
Α	Initial Release	01-Sept-2018	DM	DM
В	 Page 2, Section; 3.2, Temperature, changed Tin max to +125°C and added Palladium Nickel Gold. Page 4, Figure 2, Durability row, added Palladium Nickel Gold: = 100 cycles. 	07-Sep-2018	DD	DM
C	 Section 3.2. (is) Current (Amp). See Appendix A for current temperature rise (t-rise) without housing (was) Current (Amp) Section 3.2 in table (is) Current Rating (A) (was) Maximum Current (A) Section 3.3 Converted tabulated performance requirements to paragraph style. Added 3.3.4. Maximum Current Capability test Added Appendix A: T-Rise curves 	06-May-2020	DM	DM
C1	 Page 2. Section 3.2 Current Rating. Corrected typo for size 16 16 AWG (is) 13A (was) 16A Page 2. Section 3.2. Added note 2 to clarify metric wires are ref only 	16-Oct-2020	DM	IG
C2	 Page 2. Section 3.2 Current Rating. Added missing 14 [2.00] for size 20. Page 3. Section 3.3.3 Contact Resistance. Added missing 14 [2.00] for size 20. Page 4. Section 3.3.5. Crimp Tensile. Added missing 14 [2.00] for size 20. 	07-May-2021	DM	IG
D	 Page 2. Section 2.2 Added USCAR-2 Page 8 & 9. Section 3.4 Added size 20 T-Rise curves 	07-Jun-2021	DM	IG
E	 Page 5. Sec. 3.3.8 (is) .200 [5.08] deep (was) .250 [6.35] deep. Page 5. Sec. 3.3.8 Size 16 Test Pin (is) 2.50 [11.1] & Ø.0615 [1.562] (was) 2.80 [12.5] & Ø.0625 [1.588]. Page 5. Sec. 3.3.8 Size 20 Test Pin (is) 1.50 [6.7] & Ø.0410 [1.041] (was) 1.50 [6.7] & Ø.0402 [1.021]. 	18-Feb-2022	DM	IG
F	1) Page 4. Sec 3.3.5 Crimp Tensile. Separate AWG & mm² columns	20-May-2022	DM	IG
F1	 Page 9. Sec 3.4 Correct plating code error for Size 20 Gold PN Table. Gold plating code (is) 44 (was) 22 Page 10. Sec 3.4 Correct plating code error for Size 20 Tin PN Table. Tin plating code (is) 77 (was) 22 	27-Jan-2023	DM	IG

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